Micro Array Hole Formation in Glass Using Electrochemical Discharge Machining

Liang Huang¹, Yan Cao¹*, Feng Jia¹, Yan Lei²

¹ Department of Mechanical Design, College of Mechatronic Engineering, Xi’an Technological University, Xuefu Middle Street, Wei Yang District, Xi’an City, China
² Tool Structure Manufacturing, Xi’an KunLun Industry (Group) Company with Limited Liability, Xingfu North Street, Xin Cheng District, Xi’an City, China
*E-mail: caoyan@xatu.edu.cn

Received: 5 July 2019 / Accepted: 9 August 2019 / Published: 30 August 2019

With the widespread application of non-conducting tough materials, such as glass in MEMS recent years, many difficulties have arisen in the processing of these kind of material with eigen-structure characteristics. In this paper, based on the technical advantages of electrochemical discharge machining, the mechanism of tool electrode structure and process parameters for the stability of gas film, processing efficiency and forming quality is analysed, and the machining of a glass micro-array hole is accomplished by obtaining the optimal process parameters.

Keywords: ECDM; micro array holes; gas film.

1. INTRODUCTION

Currently, with the rapid development of science and technology, there are an increasing number of non-conducting tough materials, because these materials have excellent characteristics such as high hardness, high brittleness, corrosion resistance and insulation. Thus, these materials are becoming more widely used in micro-accelerometers, micro-flow sensors, micro-reaction containers and other MEMS [1, 2], such as glass. Because glass also has the above material properties listed above, the traditional machining method becomes very difficult. Therefore, non-traditional machining methods are proposed, such as abrasive flow machining, laser machining, and ultrasonic machining [3-14]. However, these machining methods can not solve problems such as poor surface quality and wide heat-affected zones. To overcome these limitations, many scholars have explored the appropriate processing method for the above materials, electrochemical discharge machining (ECDM).
ECDM is a special micromachining method based on electrochemical discharge phenomena. ECDM was first proposed and applied to the processing of glass materials by Kurafuji in Japan in 1968 [15]. This technology is a simple device, that can process complex two-dimensional or threedimensional microstructures on the workpiece by controlling the moving track of the electrode. Meanwhile, the processing quality of ECDM is also easy to control. This research plays an important role in promoting the development of MEMS. As shown in figure 1, the working principle of this technology is to melt and remove the workpiece material by using the high temperature that is produced by the discharge at the top of the tool electrode. Its components include a tool electrode, an auxiliary electrode, a workpiece, an electrolyte and an electric source. At the beginning of processing, the tool electrode is connected to the positive end of the electric source, and the auxiliary electrode is connected to the negative end of the electric source. When voltage is applied on the electrode, the hydrogen bubbles produced by electrochemical reaction gather on the surface of the tool electrode. When the air bubbles continue to accumulate and reach a certain degree, a thick gas film is formed. The gas film separates the solution from the tool electrode in an instant, and produces a potential gradient between the electrolyte and the tool electrode, thus forming an electric field. When the electric field reaches a certain intensity (usually \(10^7 \text{V/m}\)) [16, 17], spark discharge occurs between the tool electrode and the electrolyte. If the tool electrode and the workpiece are close to each other, the high temperature produced by the spark discharge acts on the surface of the part, and the workpiece can be removed by thermal corrosion and high temperature chemical corrosion [18].

Because the mechanism of the ECDM is complicated, the process is influenced by the multiphysical field (including the electric field, the flow field and the temperature field). In addition, the unstable gas film can lead to the instability of the discharge energy, which in turn affects the removal performance of the material. Therefore, some scholars have studied the characteristics of ECDM, including: American scholar Jiang et al. compared the discharge model with the actual discharge, and analysed the hydrodynamic characteristics of the separated air bubbles [19]. Indian scholar Dafade et al. [20] stressed the importance of understanding the discharge mechanism, and found that the ECDM is very dependent on the material and processing parameters of the workpiece. Wuhrich et al. [21] proposed that ECDM has two characteristic mechanisms, namely, a discharge mechanism and a heat conduction mechanism, and found that the corrosion of ECDM is caused mainly by hot corrosion and chemical corrosion. The formation of a gas film in the ECDM environment using a stainless-steel or a tungsten carbide tool cathode in different glass materials has been studied in the literature [22-24]. In addition, scholar Gupta et al. also discussed the effects of different process parameters on the thermal stress of hole-forming in the process of ECDM [25, 26].

Because the above research is based mainly on a single micro-hole, at the same time, the electric source parameters and thermal parameters are not connected for consideration in the research process. In addition, the tool electrode structure proposed in reference [27, 28] has not been considered for the generation of the thickness of the gas film. For this reason, this paper takes the array holes as the object, carries on the mechanistic analysis and the parameter research to the above problem that is less researched, and puts forward the mechanism of action of the parameters, thus laying the foundation for the optimal selection of the technological parameters of the glass array holes.
Nomenclature

\( V_1 \) Input voltage

\( I_{AI} \) Average input current

\( T_P \) Time of pulse

\( \eta \) Conversion fraction of thermal energy

\( V_{IW} \) Input voltage for WEDM

\( I_{IC} \) Input Current for WEDM

\( F_F \) Feed rate for WEDM

\( D_t \) Top hole diameter

\( D_b \) Bottom hole diameter

\( H \) Glass thickness

2. EXPERIMENTAL SECTION

2.1. Selection of experimental equipment and parameters

In this paper, the structure diagram of the previously designed and developed ECDM experimental device is shown in figure 1. The experimental equipment is mainly composed of a computer control system, a pulse electric source, an oscilloscope, a voltage probe, a current probe, a spindle, a tool electrode, an auxiliary electrode, an electrolyte and a working chamber. The working chamber is made of organic glass material, and its size is 12x9x6 cm\(^3\) (Table 1 shows the experimental plant parameters). Meanwhile, the forming holes were examined by a Leica optical microscope (model: DM2500P+7HMS).

![Figure 1. ECDM experimental device. The device consists mainly of the following parts: Control system; Pulsed electric source; Voltage probe; Oscilloscope; Current probe; Auxiliary electrode; Electrolyte; Chamber; Tool electrode.](image)

(The operational principle of the equipment is introduced in the third paragraph of the INTRODUCTION, and the range of its process parameters is shown in Table 1)
Table 1. ECDM experimental equipment plant parameters

<table>
<thead>
<tr>
<th>Plant Parameters</th>
<th>Values</th>
</tr>
</thead>
<tbody>
<tr>
<td>Impulse Frequency (Hz)</td>
<td>100 to 5000</td>
</tr>
<tr>
<td>Duty Cycle (%)</td>
<td>10 to 90</td>
</tr>
<tr>
<td>Input Voltage (V) (Combined critical gas film breakdown voltage test)</td>
<td>45 to 90</td>
</tr>
<tr>
<td>Feed Speed (µm/sec)</td>
<td>2</td>
</tr>
<tr>
<td>Electrolyte Concentration (%)</td>
<td>10</td>
</tr>
<tr>
<td>Counter of Tool Electrode</td>
<td>Ring of Ø100mm</td>
</tr>
<tr>
<td>Workpiece Thickness</td>
<td>0.3mm</td>
</tr>
<tr>
<td>Machining Gap (radial)</td>
<td>60mm</td>
</tr>
<tr>
<td>Feed depth</td>
<td>1.5mm</td>
</tr>
<tr>
<td>Machining Gap (lengthwise)</td>
<td>Touch</td>
</tr>
</tbody>
</table>

2.2. Structure design of tool electrode for glass array holes

Considering that stainless steel has a smaller tool wear rate when it is used as tool electrode [22], this paper takes stainless steel as the tool electrode material, ultra-white glass as the workpiece and array holes with three rows and three rows of structure as the goal, combined with the following WEDM parameters ($V_{IW}=70$ V, $I_{IC}=1.5$ A, $T_{P}=12$ µs, $F_{F}=1.5$ mm/min) to complete the fabrication of the tool electrode.

Figure 2. (a) When the tool length is less than 10 mm and the pitch is less than 1 mm, a large number of bubbles are produced in the machining gap (unable to machine); (b) When the tool length is less than 10 mm, the pitch is less than 1 mm and the input voltage is increased. The bubbles produced in the machining gap are reduced (able to machine); (c) When the tool length is more than 10 mm, and the pitch is more than 1 mm, the bubbles produced in the machining gap are fewer (able to machine); (Figure 2(a) shows that the tool cathode with 5 mm length and a pitch of 0.5 mm is machined in the following machining environment (Input voltage 45 V, Duty ratio 10%, Pulse frequency 100 Hz (other parameters shown in Table 1).) (Figure 2(b) shows that the tool cathode with 5 mm length and pitch 0.5 mm is machined in the following machining environment (Applied voltage 90 V, Duty ratio 10%, Pulse frequency 100 Hz (other parameters shown in Table 1).) (Figure 2(c) shows that the tool cathode with 15 mm length and pitch 1.5 mm is machined in the following machining environment (Applied voltage 45 V, Duty ratio 10%, Pulse frequency 100 Hz (other parameters shown in Table 1).)
As shown in figure 2(a), when the tool cathode length is less than 10 mm and the pitch is less than 1 mm, a large number of bubbles produced by chemical reaction pile up on the surface of cathode tools during the processing, so these bubbles not only increase the thickness of gas film, but also increase the breakdown voltage of the gas film correspondingly, which makes it difficult to break the gas film at a lower input voltage and makes the processing pause; When the input voltage is increased and reaches the breakdown voltage of the gas film, the bubbles produced in the machining gap are reduced, so the processing can continue (figure 2(b)); When the tool length is more than 10 mm, and the pitch is more than 1 mm (figure 2(c)), the bubbles produced in the machining gap are fewer (able to machine).

Because when the length and pitch of the tool are short, coupled with the fast rate of chemical reaction, a large number of gases produced between poles will evaporate and liquefy not far from the top of the tool. Because the movement distance of liquefied water droplets is short, a large number of small bubbles will be formed due to the large tension when the flow reaches the machining gap, and when the number of bubbles increases to a certain degree, the small bubbles will merge into larger bubbles and gradually form the gas film and wrap on the surface of the tool electrode. Finally the breakdown voltage is increased by increasing the thickness of the gas film. When the length and pitch of the tool increase, the droplets after liquefaction become longer, resulting in a small tension when the droplets flow to the machining gap, so it is difficult to form more bubbles to increase the breakdown voltage. Based on the above analysis, a 3×3 cathode tool as shown in figure 3 was prepared in this paper.

Figure 3. 3×3 array stainless steel tool cathode with 15 mm length and 1.5 mm pitch. (The material of the cathode tool is stainless steel, and its processing mode is wire cutting. The corresponding process parameters are as follows: $V_{W}=70\text{V}$, $I_{C}=1.5\text{A}$, $T_{P}=12\mu\text{s}$, $F_{F}=1.5\text{mm/min}$)

Compared with the neutral electrolyte, the alkaline solution $\text{OH}^-$ ion is a hydrophilic functional group. The $\text{OH}^-$ ion has a higher activity than the $\text{NO}_3^-$ ion. Therefore, under the same conditions, the gas film breakdown voltage of alkaline solution is lower than the gas film breakdown voltage of the neutral solution such as $\text{NaNO}_3$. Therefore, it is more easily machined by ECDM. Considering that the
K⁺ ion has a higher mobility than the Na⁺ ion [22], 10% KOH was selected as processing electrolyte [19].

3. RESULTS AND DISCUSSION

3.1. Selection of experimental parameters

According to the ECDM processing mechanism for the above analysis, when the input voltage is low, only the electrochemical reaction occurs, and at this time, the bubble generated in the machining gap is insufficient to form a dense gas film to cause a breakdown discharge phenomenon. Only when the input voltage exceeds the breakdown voltage of the gas film, can the electrochemical discharge effect occur. In this paper, the voltage-current characteristic curve can be used for quantitative analysis under different duty cycle conditions (as shown in figure 4). The voltage-current characteristic curve can be divided into five sections:

**Figure 4.** Voltage-current characteristic curve of electrochemical discharge effect in ECDM. (Input voltage 45-90V, Duty ratio 10%-90 (other parameters shown in Table 1).) (Cut-off region: OA section, in which no electrochemical reaction can occur and no current passes through because the input voltage is too low.) (Linear region: in AB section, the relationship between current and voltage basically obeys Ohm's law, and the characteristic curve is linear. At this time, the electrochemical reaction begins to occur on the two electrodes, and a small number of bubbles are formed.) (Saturation region: in the BC section, with the increase of input voltage, the bubbles are increased and combined with each other, and the gas film attached to the surface of the tool electrode is not tight, which is like to increasing the impedance value between the electrolyte and the tool electrode. At this time, the current still increases with the increase of voltage, but it do not increase linearly.) (Jump region: in the CD section, number of bubbles are formed on the surface of the tool electrode by electrochemical reaction. It is very likely that the bubbles combine with each other to form a dense gas film structure, which makes the insulation between the electrode and the electrolyte form. The current drops sharply, and is accompanied by an unstable spark discharge. The higher the voltage, the easier it is to form the insulated gas layer, so the smaller the current is, the more obvious the spark discharge is.) (Discharge region: in the DE section, the electrochemical reaction on the surface of the tool electrode is violent,
the bubbles can be combined to form a stable gas film, and the spark discharge is carried out stably. The electrochemical discharge machining is carried out mainly in this range. Now, the higher the voltage, the greater the current, and the greater the spark discharge.)

Among these points, the C point is the critical point of transition from electrochemical reaction to spark discharge state. At this voltage, the spark discharge begins to occur, so the voltage where the C point is located is defined as the gas film breakdown voltage. Combined with the current-voltage characteristic curves of different duty cycles, the smaller the duty cycle is, the fewer the number of bubbles formed by the reaction is. Therefore, it is not easy to form an insulating gas film, resulting in an increase in the critical voltage. In this paper, the stable discharge voltage corresponding to a different duty cycle in 10% KOH solution is obtained by experiment (as shown in Table 2). Because the power supply energy below the 60% duty cycle is difficult to assure the machining of the array hole, so we only studied the case with a duty cycle of 60% or more. The above conclusion is consistent with the theory proposed by Cook and Tsutsumi et al. [29-34], in which the ECDM mechanism of glass materials in alkaline solution was studied.

Table 2. Input voltage values

<table>
<thead>
<tr>
<th>Duty Cycle (%)</th>
<th>Input Voltage(V)</th>
</tr>
</thead>
<tbody>
<tr>
<td>60</td>
<td>70</td>
</tr>
<tr>
<td>70</td>
<td>61</td>
</tr>
<tr>
<td>80</td>
<td>50</td>
</tr>
<tr>
<td>90</td>
<td>48</td>
</tr>
</tbody>
</table>

3.2. Process parameters influence on thermal energy

According to the energy calculation formula of a pulsed power supply, the heat energy generated under different process parameters can be obtained by energy conversion (such as formula 1).

\[
\text{Thermal energy} = \eta V I T_f
\]  

(1)

In the thermal analysis of ECDM by Jain et al [35-37], ECDM is equated with the phenomenon in an arc discharge valve. The three-dimensional unstable heat conduction problem is solved by using valve theory, and the conversion fraction of each thermal energy model under different processing materials is calculated by the finite element method. Therefore, in this paper, the \( \eta \) value is taken as 20%. Figure 5 shows the thermal energy produced with different process parameters at the time of the processing of the 3×3 array holes. When the impulse frequency is increasing, the thermal energy conversion condition is significantly reduced in the case of a duty cycle of 60-70%. When the duty cycle is 80%, the thermal energy conversion decreases in magnitude, and with a duty cycle of 90%, the thermal energy conversion starts to increase. Meanwhile, with the increase of the duty cycle, the amplitude of the thermal energy conversion is gradually increased. Therefore, the thermal damage of the workpiece is gradually increased. In addition, by comparing the forming quality of array holes under different process parameters, the array holes are found to have high quality with the decrease of
thermal energy conversion. At the same time, when the thermal energy conversion is below 50J/sec, the array holes have higher quality. While when the thermal energy conversion is larger than 50J/sec, the array hole quality is poor, mainly in the form of cracks.

The results show that the seepage theoretical model established by the electrochemical method (U-I diagram) of Fascio et al. [38, 39] is consistent with the experimental results mentioned above. In other words, the pulsed electric source will have a charging process before the input voltage begins to load. When the frequency is the same, the smaller the duty cycle, the longer the charging time. The more electricity the equipment outputs, the more bubbles are produced by electrochemical reaction, and the easier it is to form a dense insulating gas film. Therefore, it is easier to form a dense insulating gas film to ensure the stability of the spark discharge, and the spark discharge time is shorter at the low duty cycle, which has good moulding quality. When the duty cycle is constant, as the frequency increases, the loading voltage time of a single pulse period is correspondingly shortened, and the conversion of the thermal energy is reduced. When the duty cycle is increased, the time of the spark discharge will continue to increase, As a result, as the duty cycle increases, the decrease in thermal energy is gradually reduced.

**Figure 5.** Influence of thermal energy conversion under different process parameters. Cathode tools with 15mm length and pitch 1.5mm are machined in the following machining environment (Duty cycle 60-90% (combine with the corresponding voltage values in Table 2), Pulse frequency 100-5000Hz (other parameters shown in Table 1).
3.3. Process parameters influence on material removal rate

In the micro array holes machined by ECDM, the depth of the micro-holes increases with the prolongation of the processing time, which makes it difficult to cycle and drain the fresh electrolyte in the hole. Therefore, it will reduce the erosion effect at the bottom of the hole to a certain extent and produce a structure like the structure of the conical hole. In this paper, formula 2 can be used to describe the material removal rate (MRR) more accurately.

\[
MRR = \left( \frac{\rho}{t} \right) \left( \frac{\pi H}{12} \right) \left( D_1^2 + D_2^2 + (D_1 \times D_2) \right)
\]

(2)

The MRR (mg/min) is expressed as the sum of the material removal rates of all microspores, and the relationship between MRR and different process parameters is shown in figure 6, which is obtained by experiments.

![Figure 6. Influence of MRR under different process parameters. Cathode tools with 15mm length and pitch 1.5mm are machined in the following machining environment (Duty ratio 60-90% (And combine with the corresponding voltage values in Table 2), Pulse frequency 100-5000Hz (other parameters shown in Table 1).](image)

Combined with the above experimental results, the result are consistent with the theory proposed by Goud and Srarnya et al and a small part of the distinction [40-42]. When the impulse frequency is constant, with the decrease of the duty cycle, the input voltage increases, resulting in an increase in the spark discharge power and higher MRR during the duty cycle at 60%-70% than during the 80%-90% duty cycle. However, in the DC environment (that is impulse frequency =0), when the duty cycle is 60% and 70%, MRR is similar, and When duty cycle is 80%, MRR is less than 90%, inconsistent with the conclusion of the impulse frequency effect proposed by Kamaraj et al. [43-45].
Because when the duty cycle is at 70%, the thermal energy conversion is much larger than 60%. When the thermal energy conversion is at 90%, the duty cycle is slightly higher than 80%. Combined with the thermal energy conversion relationship corresponding to different duty cycles proposed in figure 5, the MMR characteristics produced by different duty cycles in the DC environment are caused by thermal energy to a large extent. Although the input voltage at the 90% duty cycle is slightly higher than the input voltage at the 80% duty cycle, the spark discharge duration of the 90% duty cycle is longer, so it will act on more chemical corrosion and hot corrosion to improve MMR. In the 60%-70% duty cycle environment, similar MMR is caused mainly by the large input energy difference (that is, voltage).

In addition, the MRR achieves 0.23mg/min when the duty cycle is 70%, but compared with the 60% duty cycle, the quality of the holes under other frequency parameters is poor with cracks (see figure 7), consistent with the conclusion of Section 3.2 on the influence of different duty cycles on forming quality.

**Figure 7.** Quality of corrosion under different duty ratios ((a) micro-hole arrays with poor quality; (b) micro-hole arrays with high quality) (Figure 7(a) shows that cathode tools with 15mm length and pitch 1.5mm are machined in the following machining environment (Applied voltage 61V, Duty ratio 70%, Pulse frequency 3500Hz (other parameters shown in Table 1).) (Figure 7(b) shows that cathode tools with 15mm length and pitch 1.5mm are machined in the following machining environment (Applied voltage 70V, Duty ratio 60%, Pulse frequency 3500Hz (other parameters shown in Table 1).)

### 3.4. Process parameters influence on heat affected zone width

The width of the heat-affected zone (HAZ) refers to the width of the thermal crack trace zone because the fact that part of the heat energy will act on the surface of the workpiece after the heat energy conversion. Therefore, the corresponding fossa toughness will occur and produce the width of the thermal crack trace zone. Figure 8 shows the width of the HAZ formed under different process parameters. The width of HAZ increases with the increase of the impulse frequency, but the amplitude of increase is different, which shows that the increase of the high duty cycle is low and the increase of the low duty cycle is high. The reason is related to the amplitude of thermal energy conversion discussed above.
Influence of the HAZ under different process parameters. Cathode tools with a length of 15mm and a 1.5mm pitch are machined in the following machining environment (Duty ratio 60~90% (Combine with the corresponding voltage values in Table 2). Pulse frequency 100-5000 Hz (other parameters shown in Table 1).

Combined with the analysis of the above 3.2 Sections, when the duty cycle is 60%, the HAZ width is higher because of the high input voltage and high thermal energy, and when the duty cycle is constant, the loading voltage time of a single pulse period is shortened with the increase of the impulse frequency, thus reducing the input heat and the HAZ width. However, there is the opposite of the above theory. The main reason is that with the increase of the impulse frequency, the duration of the spark energy becomes shorter, which leads to the mechanical contact between the tool and the workpiece, indicating that the mechanical damage occurs in the form of micro-cracks. When the duty cycle is 90%, the second HAZ width will occur due to the prolongation of the spark action time, while the increase of the impulse frequency in figure 5 will lead to the increase of the HAZ width. In addition, when the duty cycle is in the range of 70%-80%, the input energy decreases with the increase of the impulse frequency, but the smaller the duty cycle is, the more slowly the HAZ width increases. Figure 9 shows the forming quality of the two kinds of array holes mentioned above (micro-array holes with the 90% duty cycle and without 70% duty cycle micro-cracks).
Figure 9. Quality of corrosion under different HAZs (micro-hole arrays with micro-cracks (a) and smooth profile (b)) (Figure 9(a) shows that cathode tools with 15mm length and pitch 1.5mm are machined in the following machining environment (Applied voltage 48V, Duty ratio 90%, Pulse frequency 4500Hz (other parameters shown in Table 1).) (Figure 9(b) shows that cathode tools with 15mm length and pitch 1.5mm are machined in the following machining environment (Applied voltage 61V, Duty ratio 70%. Pulse frequency 4500Hz (other parameters shown in Table 1).)

Combined with the analysis of the above process parameters for the moulding quality and efficiency, this paper selects the best moulding process parameters to verify the trial processing. Figure 10 shows the 3×3 and 2×6 array holes successfully machined with the optimal process parameters (10% KOH electrolyte, 61V input voltage, 3500Hz impulse frequency and 70% duty cycle)

Figure 10. Successful machining of 3×3 and 2×6 micro array holes (Cathode tools with a length of 15mm and a 1.5mm pitch are machined in the following machining environment (Applied voltage 61V, Duty ratio 70%, Pulse frequency 3500Hz (other parameters shown in Table 1).)
4. CONCLUSIONS

To solve the problem of difficult machining of glass micro array holes in MEMS, a machining method of ECDM using an array tool cathode is proposed in this paper. First, the effect of different tool electrode lengths and pitches on the breakdown voltage of the gas film is analysed and the tool structure is optimized. Second, the heat energy conversion, MRR and HAZ width under different process parameters are studied by using the optimized tool structure. Finally, the high-quality machining of different array micro-holes is realized by using the reasonable machining parameters analysed above.

ACKNOWLEDGEMENTS

This research is funded by National Natural Science Foundation of China (NSFC) under grant number 51705392, the project of 2018 Shaanxi province key research and development projects under grant number 2018ZDXM-GY-077 and 2017 Shaanxi province special processing key laboratory open fund under grant number 2017SXTZKFJG04.

References

2. F. Yang, G.W. Han, J. Yang, M. Zhang and J. Ning, Micromachines, 10 (2019) 1.

© 2019 The Authors. Published by ESG (www.electrochemsci.org). This article is an open access article distributed under the terms and conditions of the Creative Commons Attribution license (http://creativecommons.org/licenses/by/4.0/).